

Vishay Siliconix

# N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}$ ( $\Omega$ )	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)	
	$0.034 \text{ at V}_{GS} = 4.5 \text{ V}$	9 <sup>a</sup>		
20	$0.040 \text{ at V}_{GS} = 2.5 \text{ V}$	9 <sup>a</sup>	6.14 nC	
	0.054 at V <sub>GS</sub> = 1.8 V	9 <sup>a</sup>		

#### **FEATURES**

- · Halogen-free
- TrenchFET® Power MOSFET
- New Thermally Enhanced PowerPAK® SC-75 Package

Load Switch, PA Switch and Battery Switch for Portable

- Small Footprint Area
- Low On-Resistance

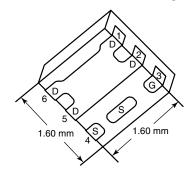
**APPLICATIONS** 

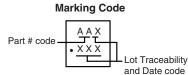
DC/DC Converter

Devices



### PowerPAK SC-75-6L-Single





Ordering Information: SiB412DK-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_A = 25  ^{\circ}C$ , unle	ss otherwise r	noted		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		$V_{DS}$	20	V	
Gate-Source Voltage		$V_{GS}$	± 8	V	
	T <sub>C</sub> = 25 °C		9 <sup>a</sup>		
Continuous Drain Current (T <sub>.I</sub> = 150 °C)	T <sub>C</sub> = 70 °C	I <sub>D</sub>	9 <sup>a</sup>		
Continuous Brain Guirent (1) = 130 G)	T <sub>A</sub> = 25 °C		6.6 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		5.29 <sup>b, c</sup>	Α	
Pulsed Drain Current		I <sub>DM</sub>	20		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	- I <sub>S</sub>	9 <sup>a</sup>		
	T <sub>A</sub> = 25 °C		2 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		13	W	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	- P <sub>D</sub>	8.4		
	T <sub>A</sub> = 25 °C		2.4 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		1.6 <sup>b, c</sup>		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C		
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>					260

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 5 s	$R_{thJA}$	41	51	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	$R_{thJC}$	7.5	9.5	]	

#### Notes:

- a. Package limited.
- b. Surface Mounted on 1" x 1" FR4 Board.
- d. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SC-75 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under Steady State conditions is 105 °C/W.

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<b>SPECIFICATIONS</b> $T_J = 25  ^{\circ}C$							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	1				T		
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		20.9		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	5 '		- 2.82			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.35		1	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA	
		$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	15			Α	
		$V_{GS} = 4.5 \text{ V}, I_D = 6.6 \text{ A}$		0.028	0.034		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 2.5 \text{ V}, I_D = 5.5 \text{ A}$		0.033	0.040	Ω	
		V <sub>GS</sub> = 1.8 V, I <sub>D</sub> = 1.8 A		0.045	0.054		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 6.6 A		23		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			535		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		85			
Reverse Transfer Capacitance	C <sub>rss</sub>			50			
		$V_{DS} = 10 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 6.6 \text{ A}$		6.77	10.16		
Total Gate Charge	Qg			6.14	9.21		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 6.6 \text{ A}$		0.96		nC	
Gate-Drain Charge	Q <sub>gd</sub>			0.96			
Gate Resistance	R <sub>g</sub>	f = 1 MHz		3.6		Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			6.6	9.9		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 1.89 $\Omega$		16	24	ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong 5.3~A,~V_{GEN}=4.5~V,~R_g=1~\Omega$		50	75		
Fall Time	t <sub>f</sub>			14	21		
<b>Drain-Source Body Diode Characterist</b>	ics			l.	<u>I</u>		
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			9	A	
Pulse Diode Forward Current	I <sub>SM</sub>				15		
Body Diode Voltage	V <sub>SD</sub>	$I_S = 3.2 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	٧	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			9.82	14.7	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	1 0 0 A di/dh 100 A/v- T 05 00		3.47	5.2	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 3.2 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$		6.46			
Reverse Recovery Rise Time	t <sub>b</sub>			3.36		ns	

#### Notes:

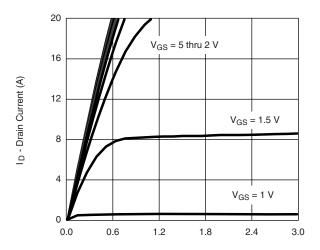
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



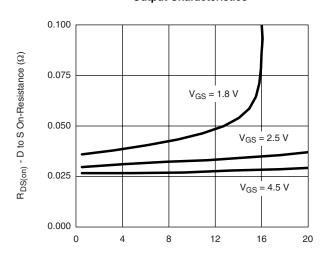
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



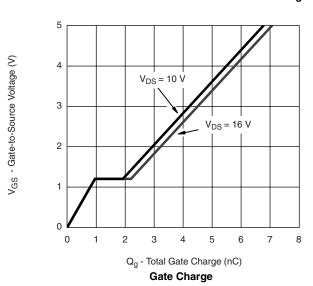
V<sub>DS</sub> - Drain-to-Source Voltage (V)

Output Characteristics



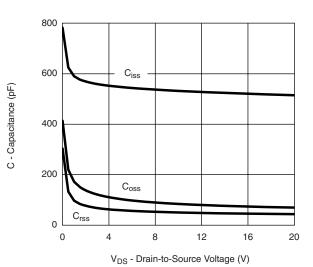
I<sub>D</sub> - Drain Current (A)

On-Resistance vs. Drain Current and Gate Voltage

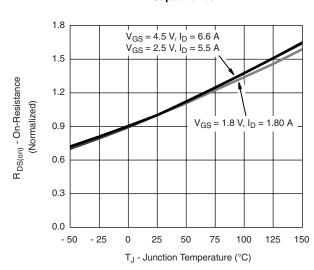


(V) Tueurn 2 T<sub>J</sub> = 25 °C T<sub>J</sub> = -55 °C T<sub>J</sub>

V<sub>GS</sub> - Gate-to-Source Voltage (V) **Transfer Characteristics** 



Capacitance



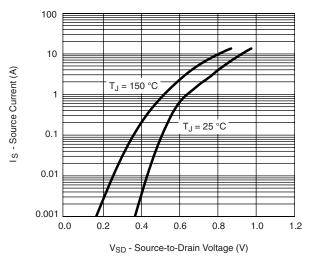
On-Resistance vs. Junction Temperature

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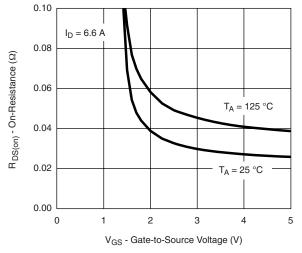
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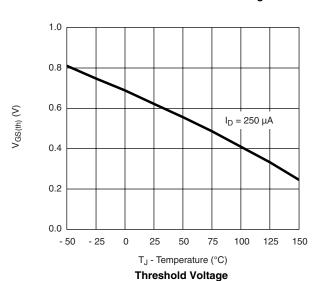
## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

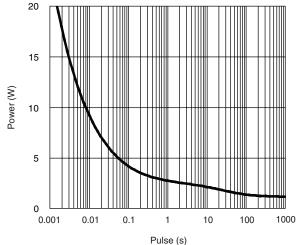


Soure-Drain Diode Forward Voltage

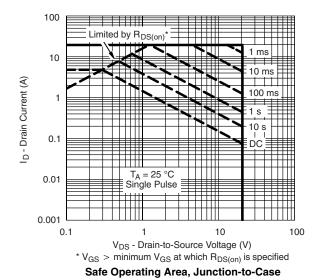


On-Resistance vs. Gate-to-Source Voltage





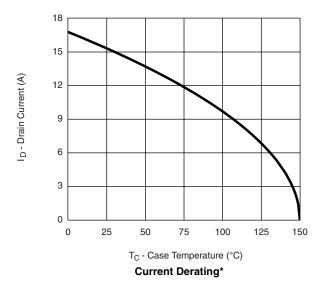
Single Pulse Power, Junction-to-Ambient

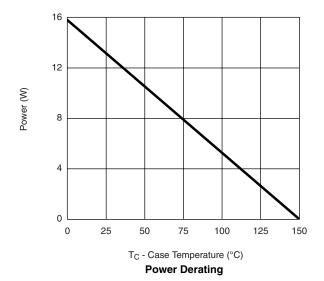




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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





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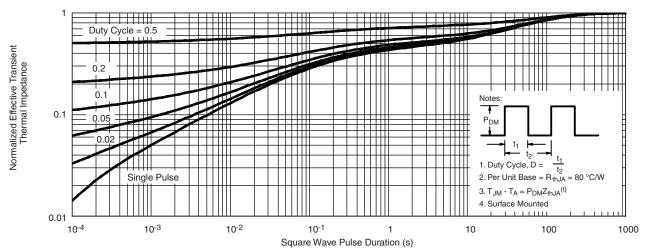
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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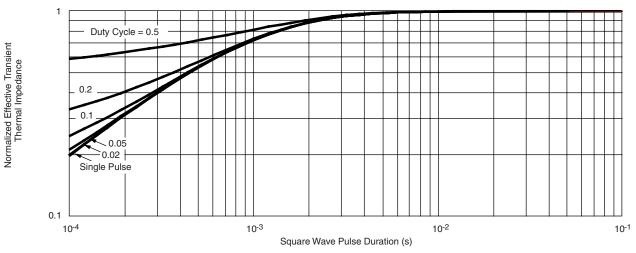
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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